JUN 14 2004
PATENT & TRADEMARK OFFICE

AF/1753
IFW

PATENT
Atty. Dkt. No. AMAT/4662/CMP/ECP/RKK

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Hey, et al.

Serial No.: 09/916,365

Confirmation No.: 7595

Filed: July 26, 2001

For: Dynamic Pulse Plating for High Aspect Ratio Features

§ Group Art Unit: 1753

§ Examiner: Arun S. Phasge

CERTIFICATE OF MAILING
37 CFR 1.8
I hereby certify that this correspondence is being deposited on June 8, 2004 with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

6/8/04
Date

Signature

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

RESPONSE TO FINAL OFFICE ACTION DATED APRIL 8, 2004

In response to the Final Office Action dated April 8, 2004, having a shortened statutory period for response set to expire on June 8, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/4662/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 5 of this paper.